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N-channel 30 V 2.1 mΩ logic level MOSFET Rev. 01 — 24 June 2009

Product data sheet

Product profile 1.

1.1 General description

Logic level N-channel MOSFET in TO220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

- High efficiency due to low switching and conduction losses
- Suitable for logic level gate drive sources

1.3 Applications

- DC-to-DC converters
- Load switiching

- Motor control
- Server power supplies

1.4 Quick reference data

Table 1. Quick reference

	Quick reference						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	-	30	V
I _D	drain current	T _{mb} = 25 °C; V _{GS} = 10 V; see <u>Figure 1</u>	[1]	-	-	100	А
P _{tot}	total power dissipation	$T_{mb} = 25 \text{ °C}; \text{ see } Figure 2$		-	-	211	W
Dynamic	characteristics						
Q_{GD}	gate-drain charge	$V_{GS} = 4.5 \text{ V}; I_D = 25 \text{ A};$		-	16	-	nC
Q _{G(tot)}	total gate charge	V _{DS} = 12 V; see <u>Figure 13</u> ; see <u>Figure 14</u>		-	55	-	nC
Static ch	aracteristics						
R _{DSon}	drain-source on-state resistance	V_{GS} = 4.5 V; I _D = 15 A; T _j = 25 °C		-	2	2.8	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 25 °C; see <u>Figure 12</u>	[2]	-	1.7	2.1	mΩ

[1] Continuous current is limited by package.

[2] Measured 3 mm from package.



N-channel 30 V 2.1 m Ω logic level MOSFET

2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		_
2	D	drain	mb	
3	S	source		
mb	D	mounting base; connected to drain		mbb076 S
			SOT78	

3. Ordering information

Table 3. Orderi	ng information	1	
Type number	Package		
	Name	Description	Version
PSMN2R0-30PL	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

(TO-220AB)

N-channel 30 V 2.1 mΩ logic level MOSFET

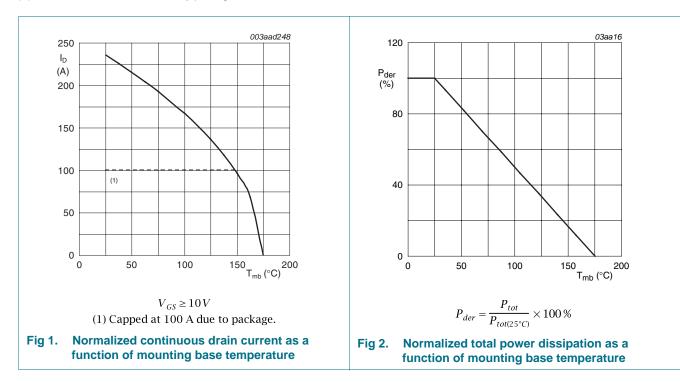
4. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

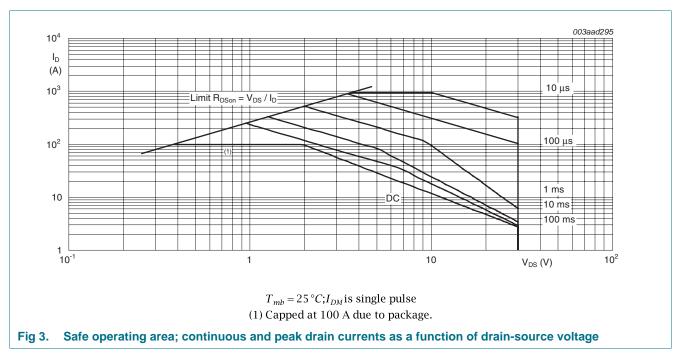
Cumple of	Deveneter	Conditions		Min	Max	11
Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	30	V
V _{DGR}	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$		-	30	V
V_{GS}	gate-source voltage			-20	20	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 100 °C; see <u>Figure 1</u>	[1]	-	100	А
		V_{GS} = 10 V; T_{mb} = 25 °C; see <u>Figure 1</u>	[1]	-	100	А
I _{DM}	peak drain current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$; see <u>Figure 3</u>		-	943	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	211	W
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-dr	ain diode					
I _S	source current	T _{mb} = 25 °C	[1]	-	100	А
I _{SM}	peak source current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$		-	943	А
Avalanche	ruggedness					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_D = 100 A; V_{sup} \leq 30 V; R_{GS} = 50 $\Omega;$ unclamped		-	555	mJ

[1] Continuous current is limited by package.



PSMN2R0-30PL

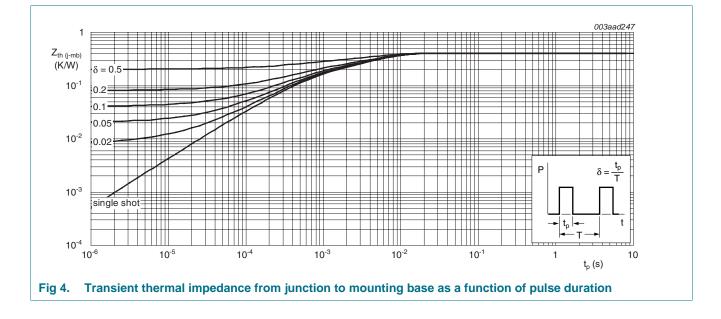
N-channel 30 V 2.1 m Ω logic level MOSFET



5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	see Figure 4	-	0.41	0.71	K/W



PSMN2R0-30PL

N-channel 30 V 2.1 mΩ logic level MOSFET

6. Characteristics

	Parameter practeristics	Conditions		Min	Тур	Max	1114
					iyp	WidX	Unit
V _{(BR)DSS}	drain-source	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ C$		30	-	-	V
	breakdown voltage	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ C$		27	-	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 9</u> ; see <u>Figure 10</u>		1.3	1.7	2.15	V
		I _D = 1 mA; V _{DS} = V _{GS} ; T _j = 175 °C; see <u>Figure 10</u>		0.5	-	-	V
		I _D = 1 mA; V _{DS} = V _{GS} ; T _j = -55 °C; see <u>Figure 10</u>		-	-	2.45	V
I _{DSS}	drain leakage current	$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	3	μA
		$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$		-	-	70	μA
I _{GSS}	gate leakage current	V _{GS} = 16 V; V _{DS} = 0 V; T _j = 25 °C		-	-	100	nA
		V_{GS} = -16 V; V_{DS} = 0 V; T_j = 25 °C		-	-	100	nA
R _{DSon}	drain-source on-state	V_{GS} = 4.5 V; I _D = 15 A; T _j = 25 °C		-	2	2.8	mΩ
resistance	V _{GS} = 10 V; I _D = 15 A; T _j = 100 °C; see <u>Figure 11</u>		-	-	3	mΩ	
		V _{GS} = 10 V; I _D = 15 A; T _j = 25 °C; see <u>Figure 12</u>	[2]	-	1.7	2.1	mΩ
R _G	gate resistance	f = 1 MHz		-	0.78	-	Ω
Dynamic	characteristics						
$Q_{G(tot)}$ total gate charge	$I_D = 25 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 10 \text{ V};$ see <u>Figure 13</u> ; see <u>Figure 14</u>		-	117	-	nC	
		$I_D = 25 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 4.5 \text{ V};$ see <u>Figure 13</u> ; see <u>Figure 14</u>		-	55	-	nC
Q _{GS}	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 4.5 \text{ V};$		-	17	-	nC
Q _{GS(th)}	pre-threshold gate-source charge	see <u>Figure 13;</u> see <u>Figure 14</u>		-	11	-	nC
Q _{GS(th} -pl)	post-threshold gate-source charge			-	6	-	nC
Q _{GD}	gate-drain charge			-	16	-	nC
V _{GS(pl)}	gate-source plateau voltage	V _{DS} = 12 V; see <u>Figure 13</u> ; see <u>Figure 14</u>		-	2.6	-	V
C _{iss}	input capacitance	V_{DS} = 12 V; V_{GS} = 0 V; f = 1 MHz;		-	6810	-	pF
C _{oss}	output capacitance	$T_j = 25 \text{ °C}; \text{ see } Figure 15$		-	1410	-	pF
C _{rss}	reverse transfer capacitance			-	650	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = 12 V; R_{L} = 0.5 Ω; V_{GS} = 4.5 V;		-	63	-	ns
t _r	rise time	$R_{G(ext)} = 4.7 \Omega$		-	125	-	ns
t _{d(off)}	turn-off delay time			-	111	-	ns
t _f	fall time			-	59	-	ns

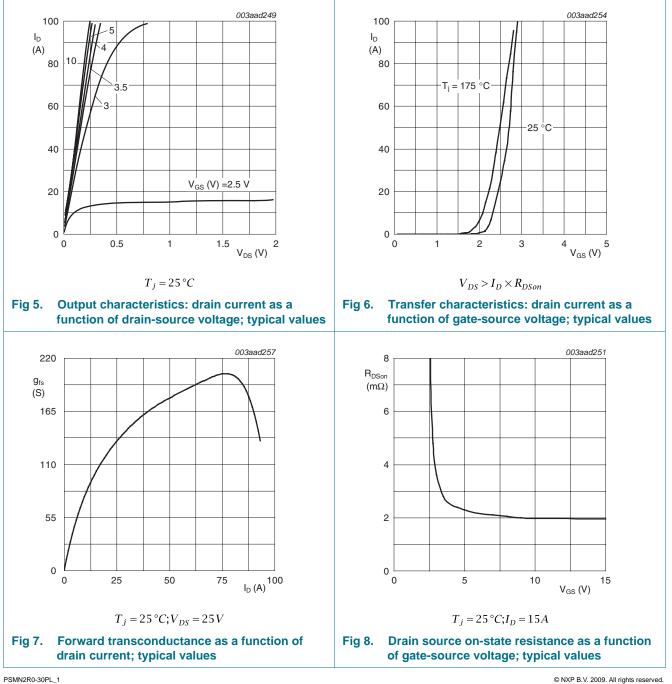
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Table 6.	Characteristics continued					
Symbol	Parameter	Min	Тур	Max	Unit	
Source-d	rain diode					
V_{SD}	source-drain voltage	I _S = 25 A; V _{GS} = 0 V; T _j = 25 °C; see <u>Figure 16</u>	-	0.76	1.2	V
t _{rr}	reverse recovery time	$I_{S} = 20 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$	-	49	-	ns
Q _r	recovered charge	$V_{DS} = 30 V$	-	66	-	nC

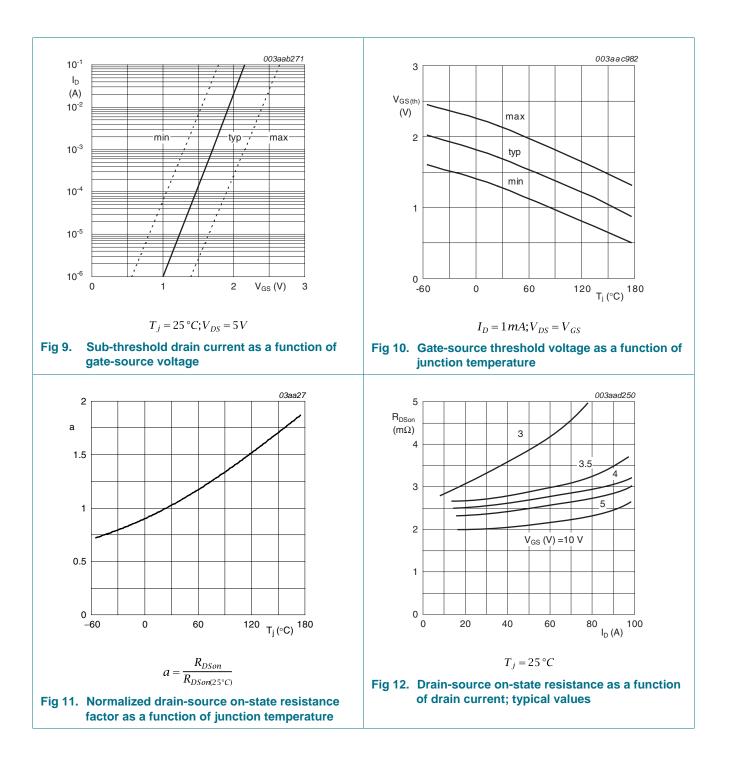
[1] Tested to JEDEC standards where applicable.

[2] Measured 3 mm from package.



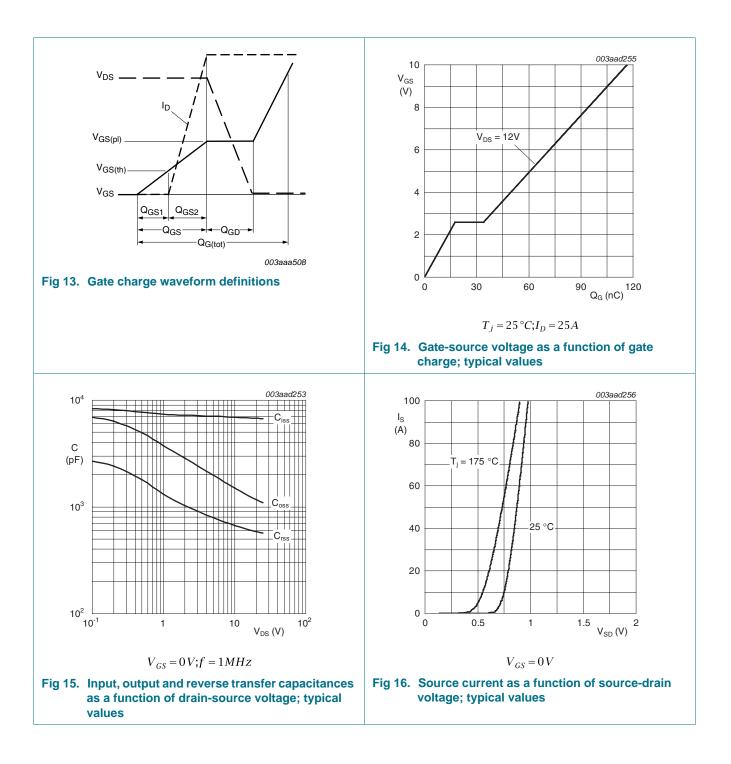
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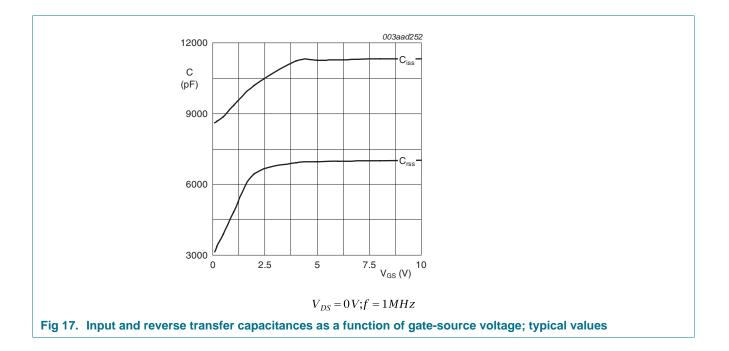
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7. Package outline

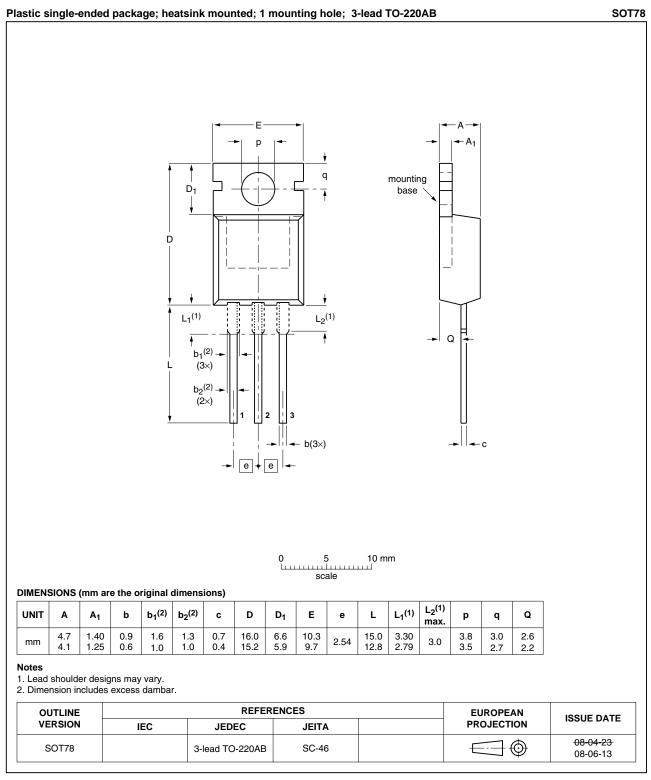


Fig 18. Package outline SOT78 (TO-220AB)

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8. Revision history

Table 7. Revision hist	7. Revision history						
Document ID	Release date	Data sheet status	Change notice	Supersedes			
PSMN2R0-30PL_1	20090624	Product data sheet	-	-			

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9. Legal information

9.1 Data sheet status

Document status [1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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